

P-Channel 30-V(D-S) Mosfet

Features

- Low $R_{ds(on)}$ @ $V_{GS} = -10V$
- TrenchFET Power MOSFET
- Halogen-free, RoHS Compliant
- Surface Mount Package
- Lead free in comply with EU RoHS 2011/65/EU directives

Mechanical Data

- Case: SOT-23
- Approx. Weight: 8.1mg

Applications

- Load Switch
- Notebook
- Battery Protection
- Hand-Held Instruments

Product Summary

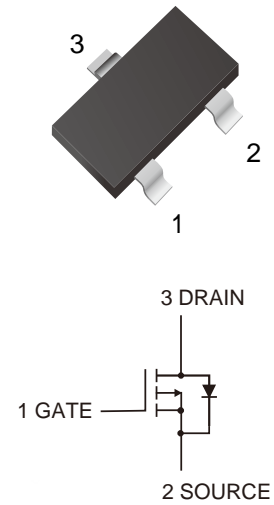
VDS	-30V
RDSON(@ $V_{GS} = -10V$)	< 55m Ω
RDSON(@ $V_{GS} = -4.5V$)	< 85m Ω

Ordering Information

Part Number	Marking	Shipping	Reel
LTM3407P-TR3	A79T or 3407	3000PCS Tape&Reel	7 inches
LTM3407P-TR12	A79T or 3407	12000PCS Tape&Reel	13 inches

Maximum Ratings (Ta=25°C unless otherwise noted)

Parameters	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	-4	A
Pulsed Drain Current (note 1)	I_{DM}	-16	A
Maximum Power Dissipation	P_D	1.25	W
Thermal Resistance from Junction to Ambient (note 2)	$R_{\theta JA}$	100	$^{\circ}C/W$
Junction and Storage Temperature	T_J, T_{STG}	-50~+150	$^{\circ}C$



Electrical Characteristics ($T_a=25$ unless otherwise specified)

Parameters	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-30			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = -30V, V_{GS} = 0V$			-1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 100	nA
Gate threshold voltage (note 3)	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-1	-1.6	-2.2	V
Drain-source on-resistance (note 3)	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -4A$		44	55	m Ω
		$V_{GS} = -4.5V, I_D = -3A$		68	85	m Ω
Diode forward voltage (note 3)	V_{SD}	$I_S = -3A, V_{GS} = 0V$		-0.84	-1.2	V

Dynamic Characteristics (note4)						
Input Capacitance	C_{iss}	$V_{DS} = -15V, V_{GS} = 0V,$ $f = 1MHz$		590		pF
Output Capacitance	C_{oss}			62		pF
Reverse Transfer Capacitance	C_{rss}			43		pF
Switching Characteristics (note 4)						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -15V, I_D = -1A,$ $R_G = 3.3\Omega, V_{GS} = -10V$		3.4		ns
Turn-on rise time	t_r			10.8		ns
Turn-off delay time	$t_{d(off)}$			26		ns
Turn-off fall time	t_f			7		ns
Total Gate Charge	Q_g	$V_{DS} = -15V, I_D = -4A,$ $V_{GS} = -4.5V$		5.1		nC
Gate-Source Charge	Q_{gs}			2		nC
Gate-Drain Charge	Q_{gd}			2.2		nC

*Notes :

1. Repetitive rating: Pulse width limited by maximum junction temperature
2. Surface Mounted on FR4 board, $t \leq 10$ sec.
3. Pulse test : Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production.



Characteristic Curves

Fig1. Typical Output Characteristics

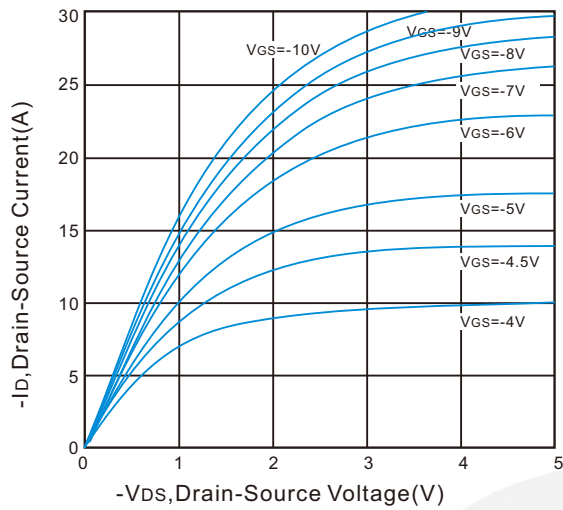


Fig2. Normalized Threshold Voltage Vs. Temperature

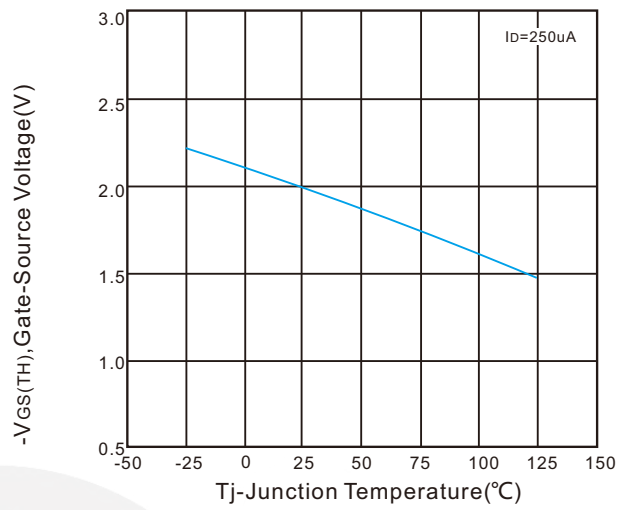


Fig3. Typical Transfer Characteristics

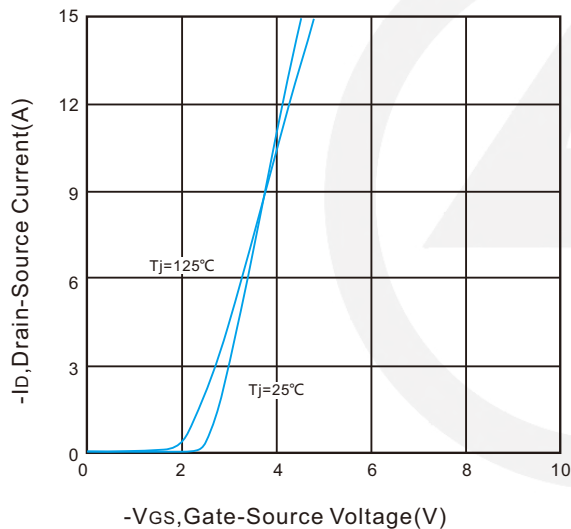


Fig4. On-Resistance VS. Drain Current and Gate

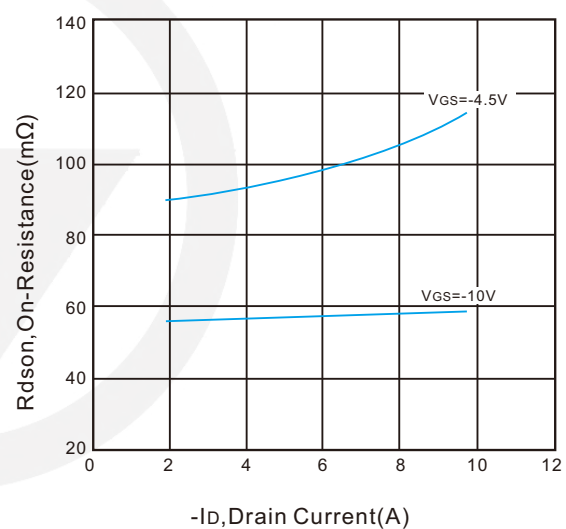


Fig5. Typical Source-Drain Diode Forward Voltage

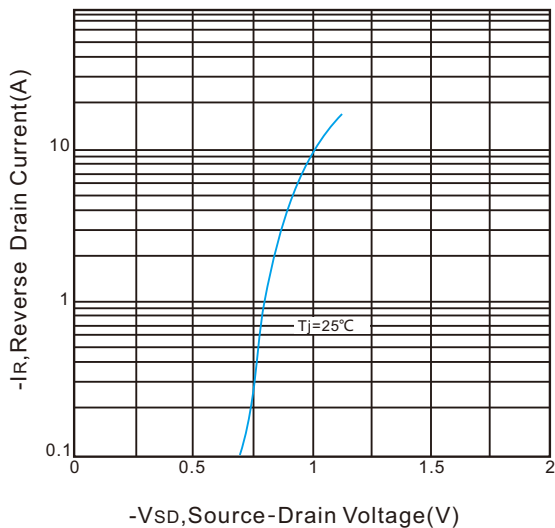


Fig6. Maximum Safe Operating Area

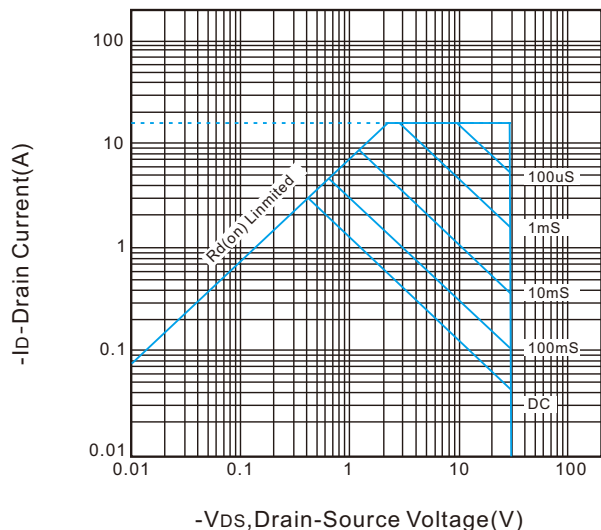




Fig7. Typical Capacitance VS. Drain-Source Voltage

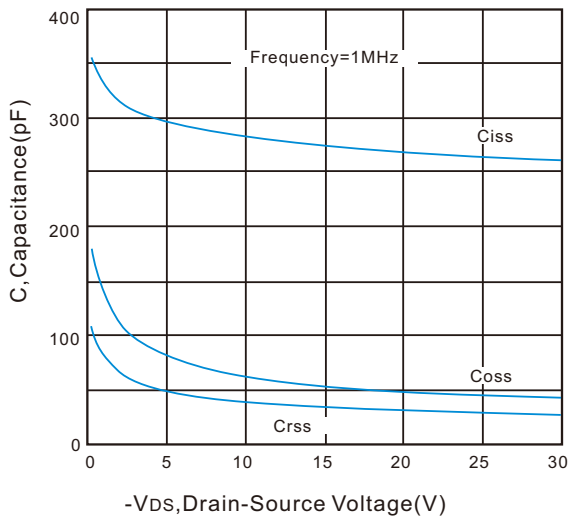
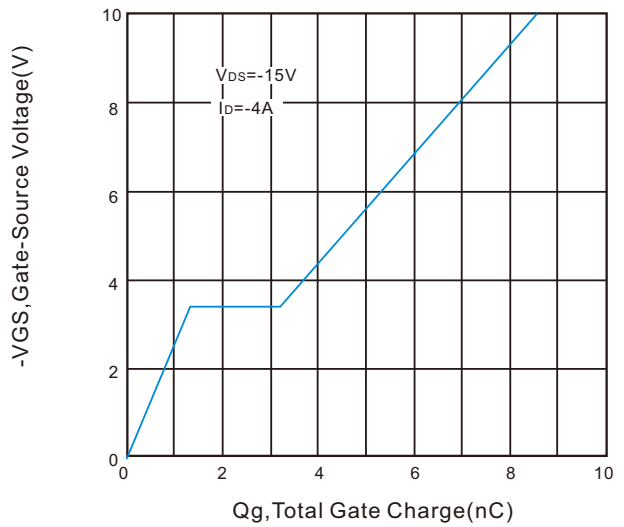
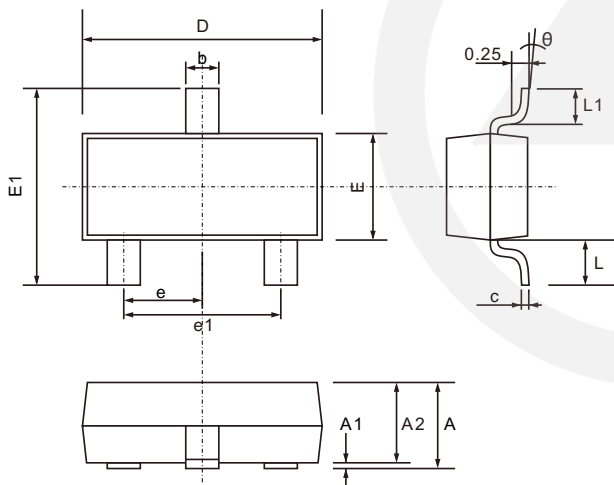


Fig8. Typical Gate Charge VS. Gate-Source Voltage



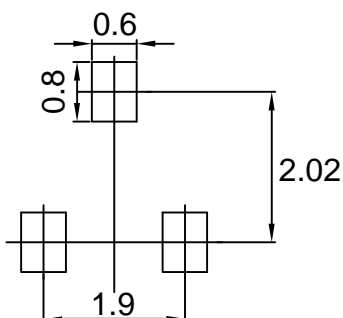
SOT-23 Package Outline

Unit: mm



SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.900	1.200
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.200
D	2.700	3.100
E	1.200	1.400
E1	2.200	2.600
e	0.950 TYP.	
e1	1.750	2.050
L	0.550 TYP.	
L1	0.300	0.500
θ	0°	8°

SOT-23 Suggested Pad Layout

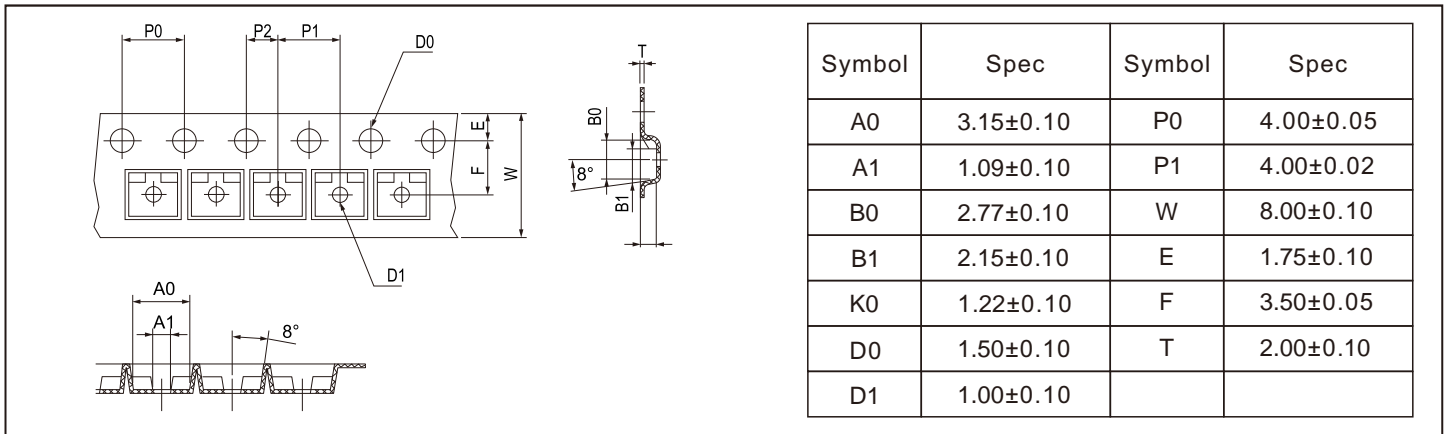


Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$
3. The pad layout is for reference purpose only.

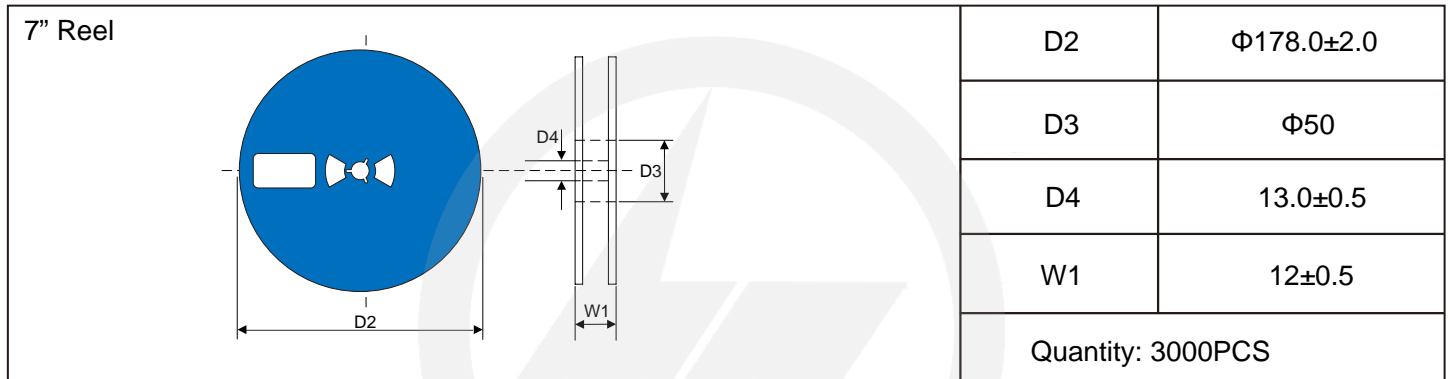
Carrier Tape Dimensions

Unit : mm



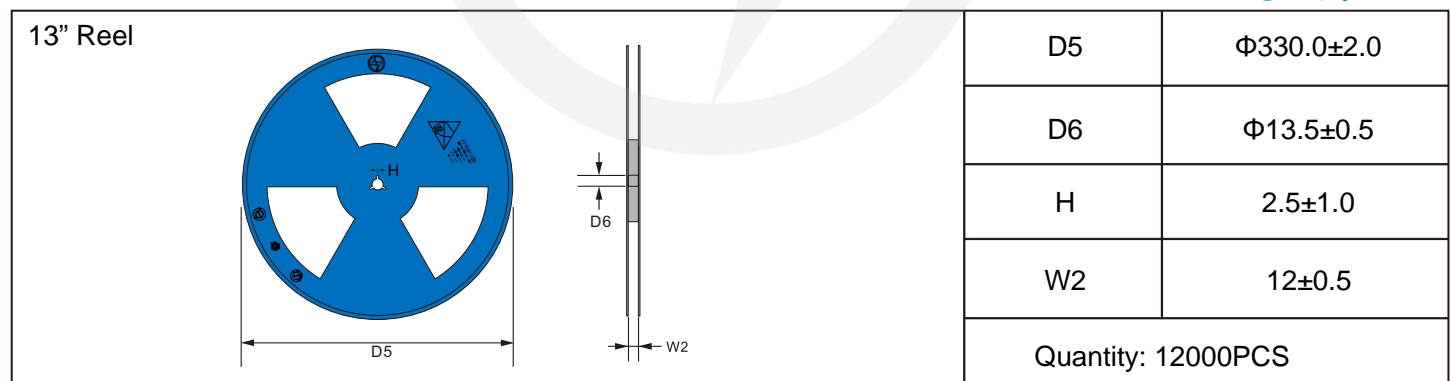
Reel Dimensions

Unit : mm

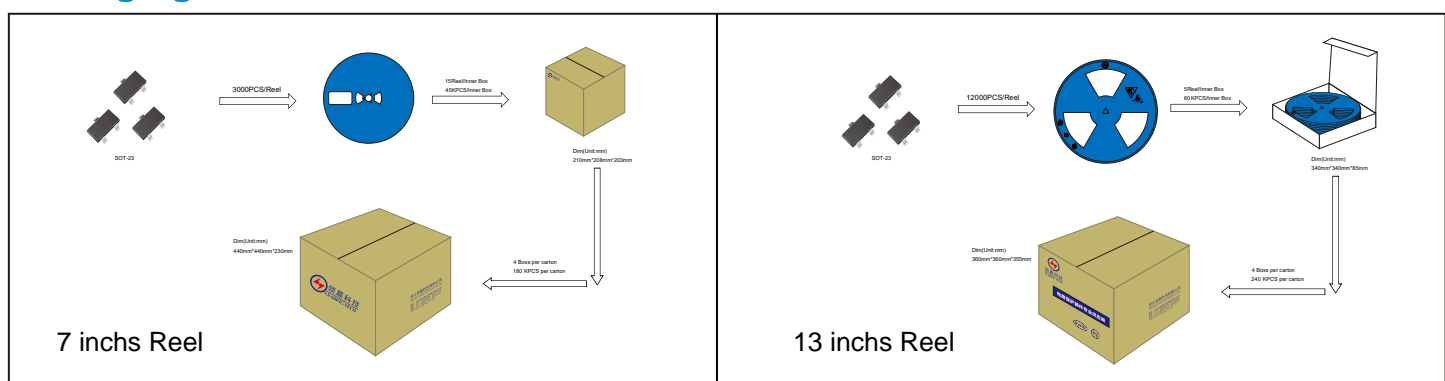


Reel Dimensions

Unit : mm



Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3°C/second max.
Preheat	
-Temperature Min ($T_{S\ min}$)	150°C
-Temperature Max ($T_{S\ max}$)	200°C
-Time (min to max) (t_s)	60-180 seconds
$T_{S\ max}$ to T_L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T_L)	217°C
-Time (t_L)	60-150 seconds
Peak Temperature (T_P)	260°C
Time within 5°C of actual Peak Temperature (t_p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision Content	Revision Reason	Revision Person	Note
01	2024.03.18	2024.03.18	3.0	New file	/	Ding	
02	2025.06.16	2025.06.16	3.1	Update packaging information	/	Ding	
03	2026.03.05	2026.03.05	3.2	Package outline E1(max)=2.6mm	/	Ding	